MAINTENANCE MANUAL
LOGIC BOARD 19D901690G5
FOR
TMX-8310, TMX-8510, & TMX-8712

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DESCRIPTION

The Logic Board controls the operation of the TMX-8310, TMX-8510, and TMX-8715 radios. It is located in the bottom of the frame assembly underneath the Audio Board. Refer to the combination manual for a complete mechanical layout.

The Logic Board contains a microprocessor and associated memory circuits which include an EPROM for controlling the processor. The software in the EPROM determines the version of TMX radio. A programmable "personality" EEPROM stores customer frequencies, tones, and options.

Refer to Figure 1 for a block diagram of the Logic Board. Refer to the Table of Contents for IC data sheets with pinout information on integrated circuits and modules.

CIRCUIT ANALYSIS

MICROPROCESSOR

Microprocessor U701 (INTEL 8032) is an 8-bit processor that performs the logical functions to provide the control signals required in the radio. An external 11.0592 MHz crystal (Y701) is used for the clock. This microprocessor controls the following:

- Synthesizer
- Transmit circuit
- Decoding of system tones
- Generation of system tones
- Transmitter and receiver audio mute gates

Serial data at a 300 baud rate is used for communication between the microprocessor and handset.

ERASABLE PROM (EPROM)

EPROM U703 is a CMOS 8-kilobyte device with an internal address latch. All information required by the microprocessor for system operation resides in this

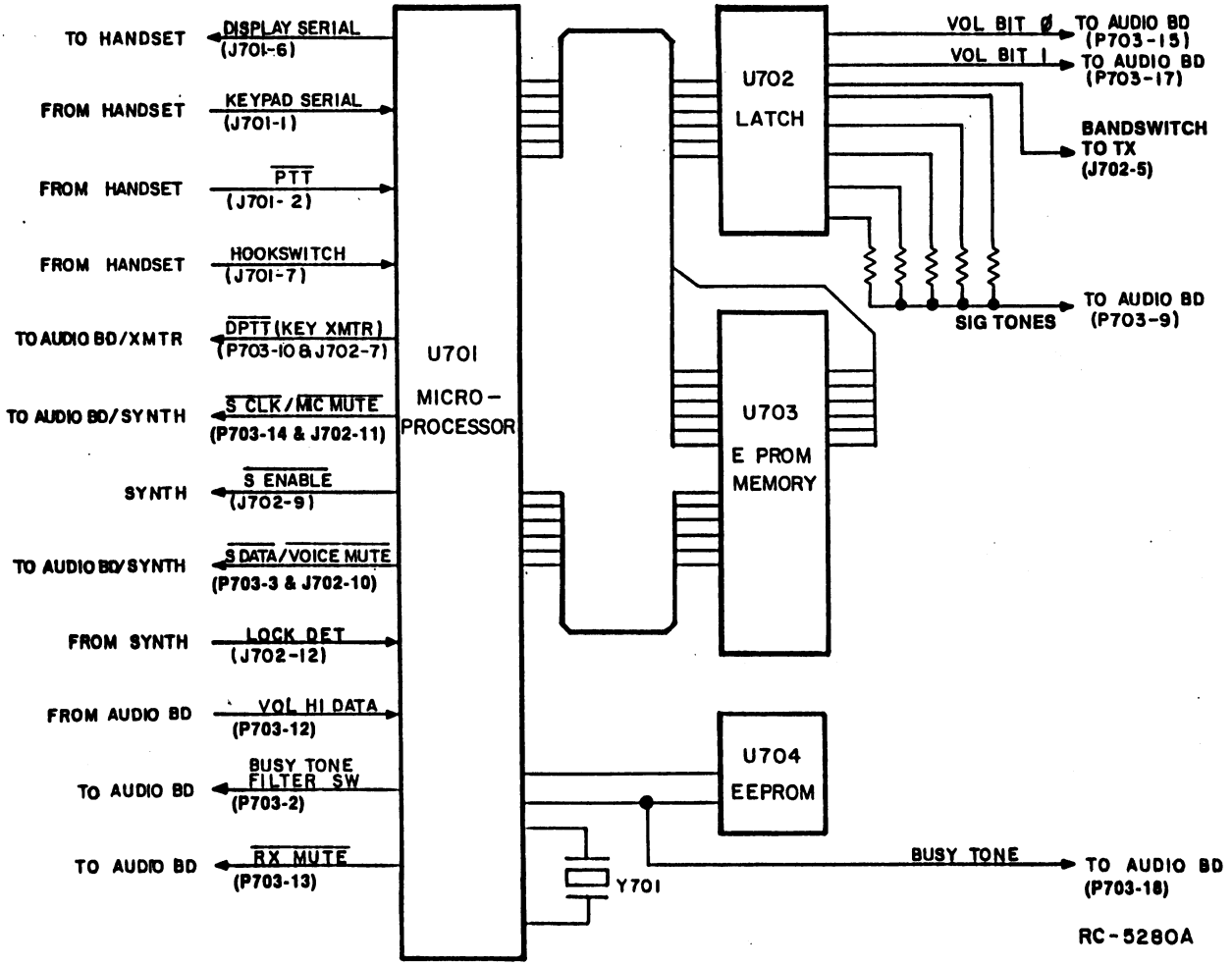


Figure 1 - Block Diagram

EPROM. The EPROM contains both the customer system software and the test software. Depending on the radio version, either the dispatch software (TMX-8310), the interconnect software (TMX-8510), or the duplex software (TMX-8712) is programmed into this device.

ELECTRICALLY ERASABLE PROM (EEPROM)

EEPROM U704 is designated the "personality" PROM. This personality PROM stores all required customer information which includes:

- Frequencies
- Tones
- 3-repertoire dialer locations in the TMX-8510
- 10-repertoire dialer locations in the TMX-8712

U704 is a 512 x 8 bit memory device for the TMX-8310 and 8510, and a 2048 x 8 bit device for the TMX-8712. The EEPROM is programmed through J701 on the Logic Board.

DC power for U704 is switched by transistor Q705. During the active high reset pulse to the microprocessor, Q705 removes +5 Vdc from U704 to reset the EEPROM. See the voltage regulator description below.

LATCH

Latch U702 is a CMOS, 3-state, non-inverting, D Flip Flop with the following functions:

- To control the volume bit "0" and volume bit "1" on the Audio Board
- To activate the band switch on the RF board
- To generate sine waves for signal tones using ladder resistor network R704

HORN RELAY

The horn relay circuit consists of NPN buffer transistor Q701 and NPN relay driver transistor Q702. The horn relay is activated by the microprocessor when a call is received. The circuit is capable of handling up to 150 milliamperes from an externally connected relay coil.

VOLTAGE REGULATOR

Voltage regulator U705 supplies a regulated +5 volts DC to the microprocessor, the EPROM and the latch circuit. A reset circuit is built into U705 to provide the microprocessor with a reset signal required during its power-up routine. Regulated +8 volts DC is supplied to regulator U705 from the 8-volt regulator U102 located on the RF board.

BATTERY VOLTAGE FILTER

Transistor circuit Q703 is a filter circuit for the A+ battery voltage. This circuit is used to reduce "alternator-whine" interference. The filtered A+ (13 volts) is used in the handset and on the audio board.

CAUTION

The CMOS Integrated Circuit devices used in this equipment can be destroyed by static discharges. Before handling one of these devices, the serviceman should discharge himself by touching the case of a bench test instrument that has a 3-prong power cord connected to an outlet with a known good earth ground. When soldering or desoldering a CMOS device, the soldering iron should also have a 3-prong power cord connected to an outlet with a known good earth ground. A battery-operated soldering iron may be used in place of the regular soldering iron.

SERVICE NOTES

If a faulty Logic Board is suspected, it may be useful to confirm this by substitution of a known good board.

DC CHECKS

Power for the Logic Board is supplied by the 8 volts on J702, Pin 3. This comes from the transmitter regulator U102.

1. Check for +5 volts ±0.25 volts on U705, Pin 5.

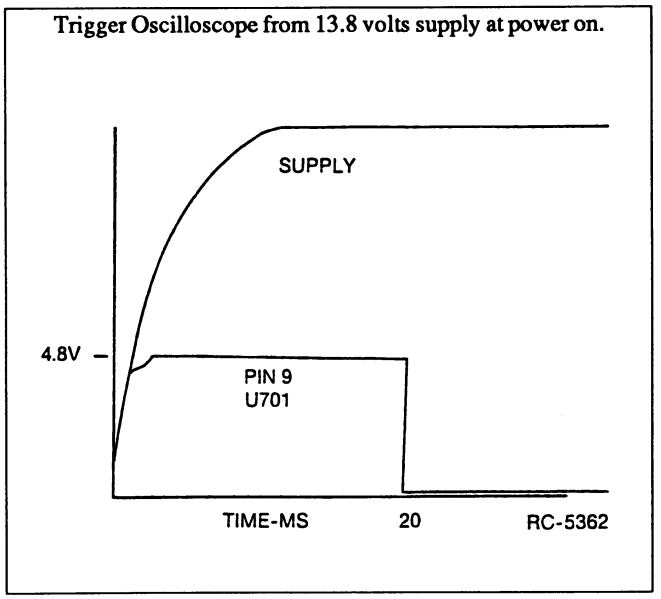


Figure 2 - Reset Waveform

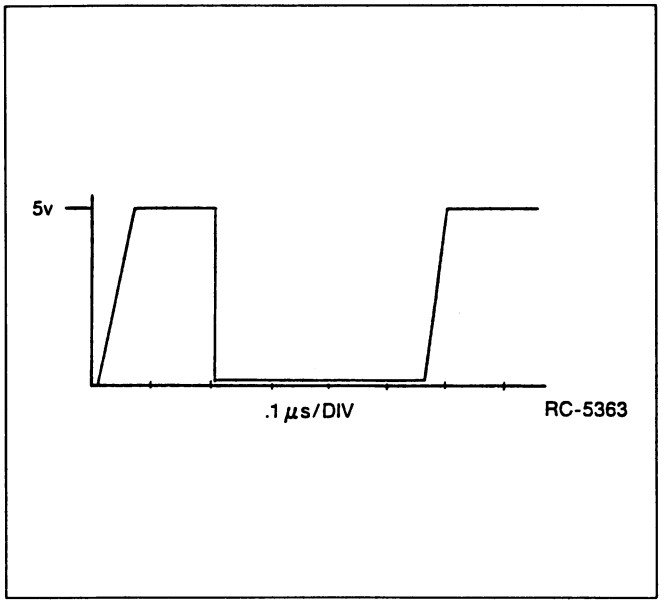


Figure 3 - ALE Clock

2. Check Power-On Reset on U701, Pin 9 (see Figure 2). if not present, check regulator U705, Pin 2 and transistor Q704.

3. Check for oscillator activity by examining the ALE clock on U701, Pin 30 (see Figure 3). If not present, examine the system clock on U701, Pin 18 (5 volts pp at 11.059 MHz). The presence of the system clock, but no ALE may indicate a bad U701. If the system clock is not present, suspect Y701 and related components.

4. All output lines from the microprocessor are pulled high to +5 volts through 50K ohm resistors inside the microprocessor. If a line is high, you may ground that pin and monitor the results. However, if a line is low, the line may not be forced to +5 volts.

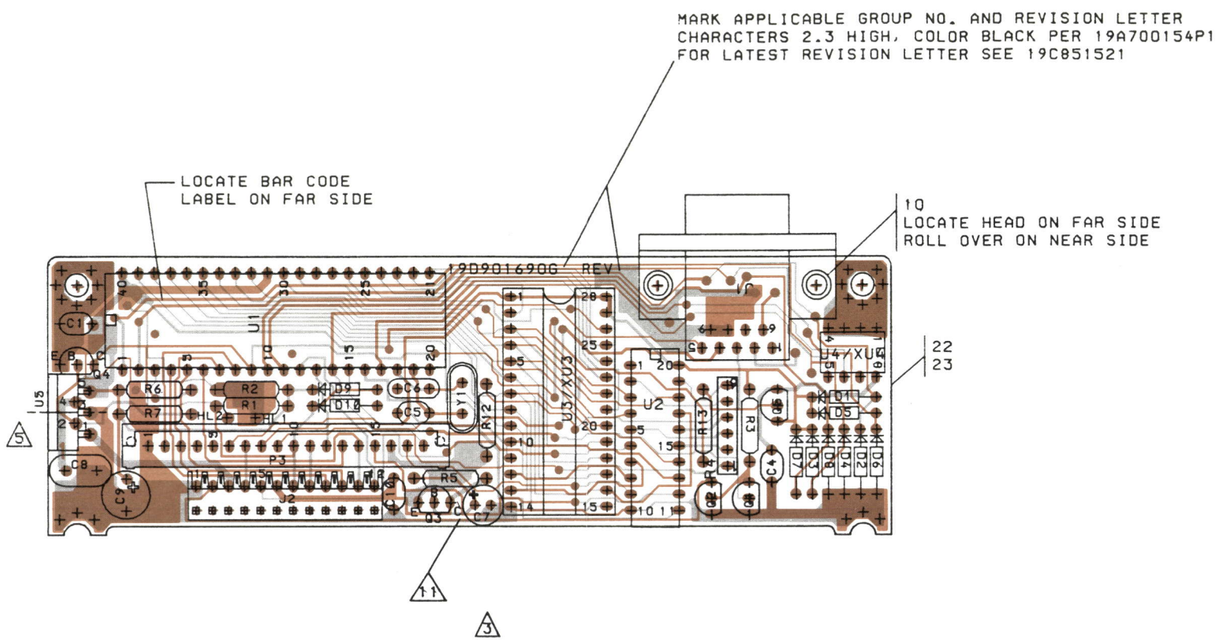
PARTS LIST

LOGIC BOARD
FOR
TMX-8310, TMX-8510, TMX-8712
19D901690G5
ISSUE 1

SYMBOL	GE PART NO.	DESCRIPTION
		- - - - - - - - - - CAPACITORS - - - - - - - - - -
C701	19A700121P106	Ceramic: 0.1 uF + or -20%, 50 VDCW.
C703	19A702052P26	Ceramic: 0.1 uF + or - 10%, 50 VDCW.
C704	19A700121P106	Ceramic: 0.1 uF + or -20%, 50 VDCW.
C705	19A700235P13	Ceramic: 10 pF + or -5%, 50 VDCW.
C706	19A700235P16	Ceramic: 18 pF + or -5%, 50 VDCW.
C707	19A704879P2	Electrolytic: 47 uF + or -20%, 16 VDCW.
C708	T644ACP410K	Polyester: 0.1 uF + or -10%, 50 VDCW.
C709	19A701534P9	Tantalum: 47 uF + or -20%, 6.3 VDCW.
C710	19A700121P106	Ceramic: 0.1 uF + or -20%, 50 VDCW.
C711 and C712	19A702061P77	Ceramic: 470 pF + or - 5%, 50 VDCW, temp coef 0 + or - 30 PPM.
C713 thru C717	19A702052P5	Ceramic: 1000 pF + or -10%, 50 VDCW.
C718 thru C720	19A702061P77	Ceramic: 470 pF + or - 5%, 50 VDCW, temp coef 0 + or - 30 PPM.
C721 thru C723	19A702061P61	Ceramic: 100 pF + or - 5%, 50 VDCW, temp coef 0 + or - 30 PPM.
C725	19A702061P77	Ceramic: 470 pF + or - 5%, 50 VDCW, temp coef 0 + or - 30 PPM.
C727 and C728	19A702061P77	Ceramic: 470 pF + or - 5%, 50 VDCW, temp coef 0 + or - 30 PPM.
		- - - - - - - - - - DIODES - - - - - - - - - -
D701 thru D710	19A700028P1	Silicon, fast recovery: fwd current 75 mA, 75 PIV; sim to Type 1N4148.
		- - - - - - - - - - JACKS - - - - - - - - - -
J701	19B209727P29	Connector.
J702	19A704779P11	Connector: sim to Molex 22-17-2122.
		- - - - - - - - - - PLUGS - - - - - - - - - -
P703	19A704874P1	Connector: sim to: Elco 00-9021-18-12-00-339.
		- - - - - - - - - - TRANSISTORS - - - - - - - - - -
Q701	19A700023P2	Silicon, NPN: sim to 2N3904.
Q702 and Q703	19A702503P2	Silicon, NPN.
Q704	19A700023P2	Silicon, NPN: sim to 2N3904.
Q705	19A700022P2	Silicon, PNP: sim to 2N3906.
		- - - - - - - - - - RESISTORS - - - - - - - - - -
R701	H212CRP210C	Deposited carbon: 1K ohms + or -5%, 1/4 w.
R702	H212CRP310C	Deposited carbon: 10K ohms + or - 5%, 1/4 w.
R703	H212CRP210C	Deposited carbon: 1K ohms + or -5%, 1/4 w.
R704	19A704885P5	Resistive Network: + or -2%, 1/8 w.
R705	H212CRP056C	Deposited carbon: 56 ohms + or -5%, 1/4 w.
R706	H212CRP247C	Deposited carbon: 4.7K ohms + or -5%, 1/4 w.
R707	H212CRP347C	Deposited carbon: 47K ohms + or -5%, 1/4 w.
R708 thru R711	19B800607P102	Metal film: 1K ohms + or - 5%, 200 VDCW, 1/8 w.
R712	H212CRP047C	Deposited carbon: 47 ohms + or -5%, 1/4 w.
R713	H212CRP247C	Deposited carbon: 4.7K ohms + or -5%, 1/4 w.
R714	19B800607P222	Metal film: 2.2K ohms + or - 5%, 200 VDCW, 1/8 w.
R715 and R716	19B800607P104	Metal film: 100K ohms + or - 5%, 200 VDCW, 1/8 w.
		- - - - - - - - INTEGRATED CIRCUITS - - - - - - - -
U701	19A703714P1	Microcomputer: HMOS, 8-BIT.
U702	19A704380P12	Digital: sim to: 74HC374.
U703	19A705686G1	Programmable Memory; Used in TMX-8310 (19C851519G2).
U703	19A704925G1	Programmable Memory; Used in TMX-8510 (19C851519G1).
U703	19A705688G1	Programmable Memory; Used in TMX-8712 (19C851519G10).
U704	19A704724P1	Digital: EE PROM; sim to XICOR X2404P. Used in TMX-8310 (19C851519G2) and TMX-8510 (19C851519G1).
U704	19A705553P1	Digital: EE PROM; sim to XICOR X24C16. Used in TMX-8712 (19C851519G10).
U705	19A704970P1	Voltage Regulator, 5 volts; sim to: SGS L387.
		- - - - - - - - - - SOCKETS - - - - - - - - - -
XU703	19A700156P3	Integrated circuit: 28 contacts; sim to AMP 640362P3.
XU704	19A700156P15	Integrated circuit: 8 positions; sim to Burndy DILB 8P-108.
		- - - - - - - - - - CRYSTALS - - - - - - - - - -
Y701	19A702511G15	Quartz: 11.059200 MHz.
		- - - - - - - - - MISCELLANEOUS - - - - - - - - -
	19B800608P156	Rivet Tube.

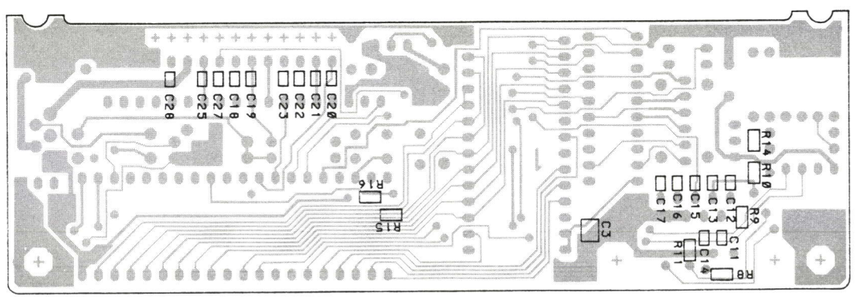
*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

COMPONENT SIDE



(19D901690, Sh. 3, Rev. 2)
(19D902178, Second Layer, Rev. 1)
(19D902178, Third Layer, Rev. 1)

SOLDER SIDE



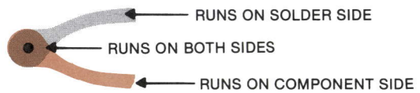
VIEW FROM BACK OF BOARD

(19D901690, Sh. 3, Rev. 2)
(19D902178, Third Layer, Rev. 1)

(21) NOTES:
1. SOLDER ALL ELECTRICAL CONNECTIONS.
2. COMPONENT LEADS TO PROTRUDE 2 MAX. BELOW SOLDER SIDE OF BOARD.
3. INDICATES FRONT OF COMPONENT AUTO-INSERTION MACHINES.

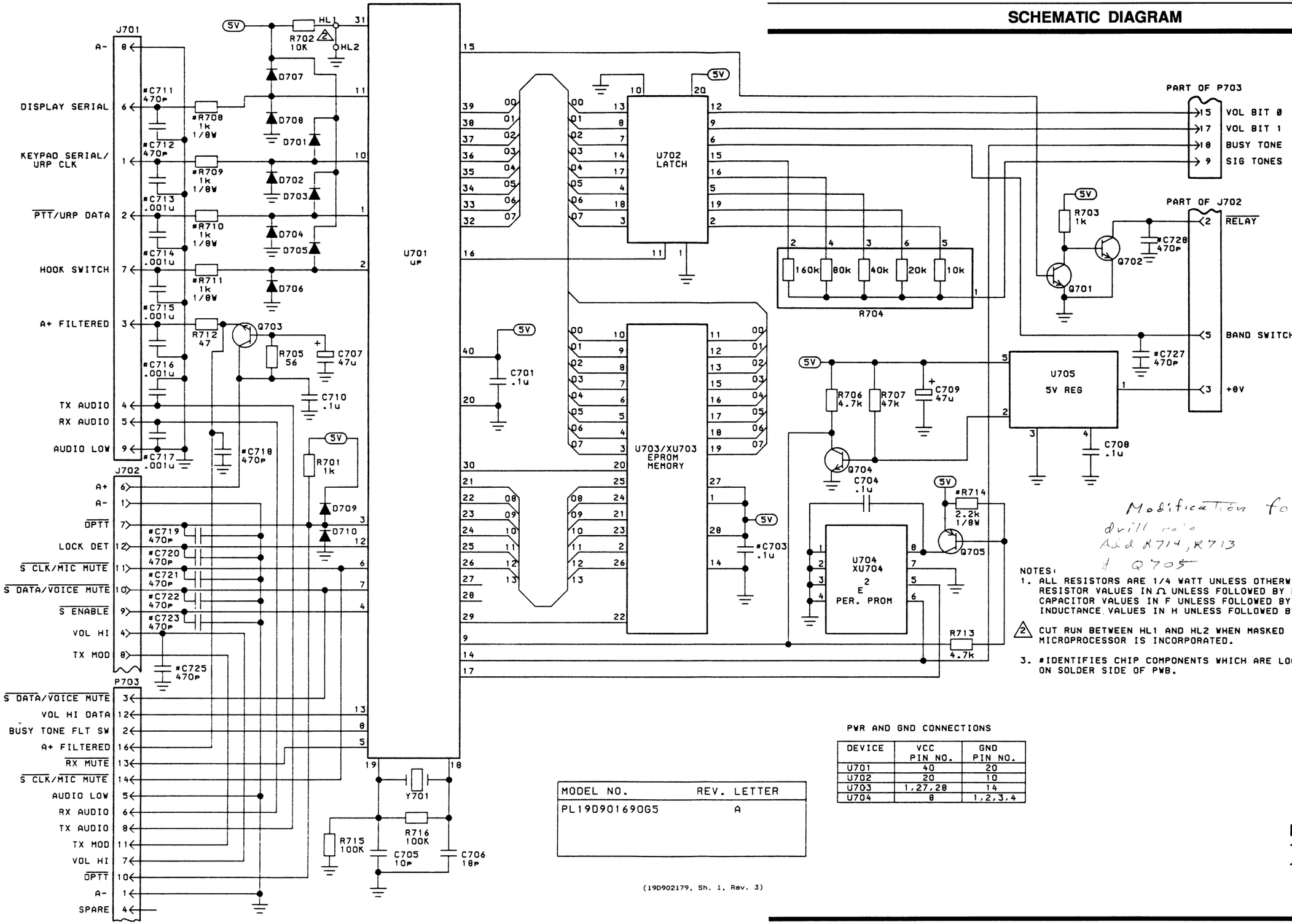
5. U5 SHALL NOT OVERHANG EDGE OF PWB.
6. P3 SHALL BE FLUSH TO PWB WITHIN 0.25.

8. REFERENCE DESIGNATIONS SHOWN ARE ABBREVIATED; FOR COMPLETE DESIGNATION ADD 700 TO NO. SHOWN. ETC J1=J701.
9. THE FOLLOWING ITEMS ARE ELECTROSTATIC SENSITIVE DEVICES REQUIRING SPECIAL CARE PER 19A701294; U1,U2, U3 AND U4.
10. THE MAX. HEIGHT ABOVE THE PWB OF ALL PARTS IN THE AI GROUP (ITEM 23) MUST BE MAINTAINED WHEN THOSE PARTS ARE NOT AI'D.
11. THE (+) LEAD OF C7 IS THE LONGEST OF THE TWO.
12. PIN 1 OF R4 IDENTIFIED BY DOT, COLOR STRIPE, VENDOR'S LOGO OR NOTCH.



CAUTION
OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC SENSITIVE DEVICES

LOGIC BOARD
19D901690G5



Modification for TMX 8210
drill hole
Add R714, R713
& Q705
TMX 8310
TMX 8510

NOTES:

1. ALL RESISTORS ARE 1/4 WATT UNLESS OTHERWISE SPECIFIED. RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER k OR M. CAPACITOR VALUES IN F UNLESS FOLLOWED BY MULTIPLIER u, n, OR p. INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR u.
2. CUT RUN BETWEEN HL1 AND HL2 WHEN MASKED MICROPROCESSOR IS INCORPORATED.
3. #IDENTIFIES CHIP COMPONENTS WHICH ARE LOCATED ON SOLDER SIDE OF PWB.

PWR AND GND CONNECTIONS

DEVICE	VCC PIN NO.	GND PIN NO.
U701	40	20
U702	20	10
U703	1,27,28	14
U704	8	1,2,3,4

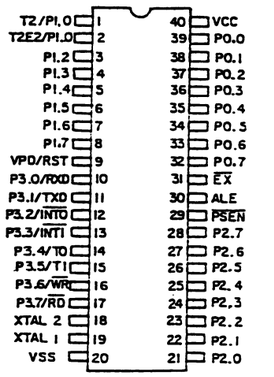
MODEL NO.	REV. LETTER
PL19D901690G5	A

(19D902179, Sh. 1, Rev. 3)

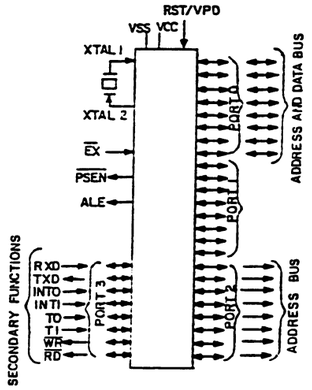
LOGIC BOARD
19D901690G5
19D902179, Sheet 1

HMOS 8-BIT MICROPROCESSOR (U701)
19A703714P1

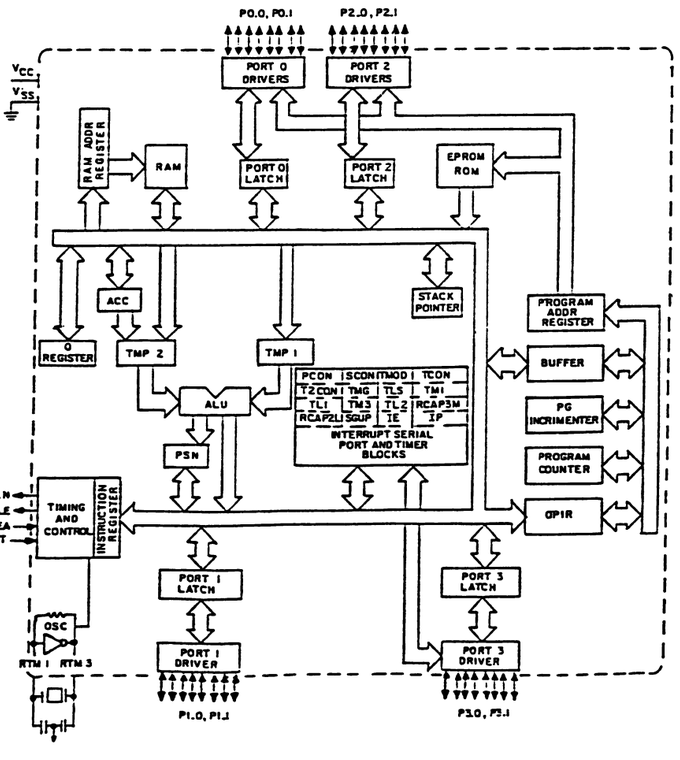
PIN CONFIGURATION



LOGIC SYMBOL



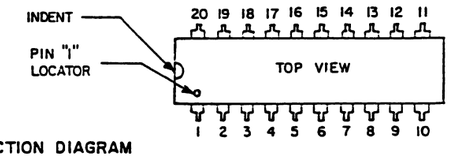
FUNCTION DIAGRAM



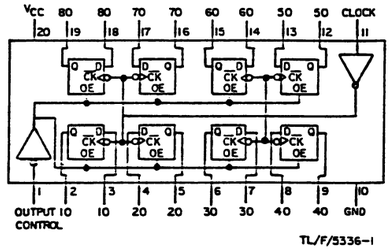
RC-7108

OCTAL 3- STATE D FLIP FLOP (U702)
19A704380P12 (74HC374)

PIN CONFIGURATION



FUNCTION DIAGRAM



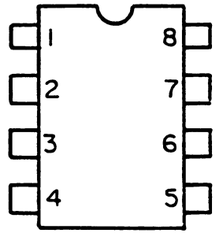
TRUTH TABLE

OUTPUT CONTROL	CLOCK	DATA	OUTPUT
L	↑	H	H
L	↑	L	L
L	L	X	Q_0
H	X	X	Z

H = HIGH LEVEL, L = LOW LEVEL
X = DON'T CARE
↑ = TRANSITION FROM LOW-TO-HIGH
Z = HIGH IMPEDANCE STATE
Q_0 = THE LEVEL OF THE OUTPUT BEFORE STEADY STATE INPUT CONDITIONS WERE ESTABLISHED.

RC-7107

(U703)
EEPROM
X24C16
19A705553P1
PIN CONFIGURATION



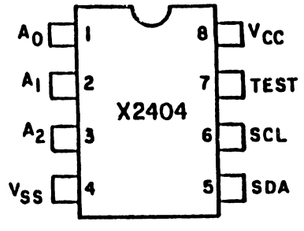
FUNCTIONS

1 TO 3	A_0 TO A_2 ADDRESS INPUTS
4	V_{SS}
5	SDA SERIAL DATA
6	SCL SERIAL CLOCK
7	TEST INPUT → TO V_{SS}
8	V_{CC}

DIGITAL 512X8 EEPROM (U704)
19A704724P1

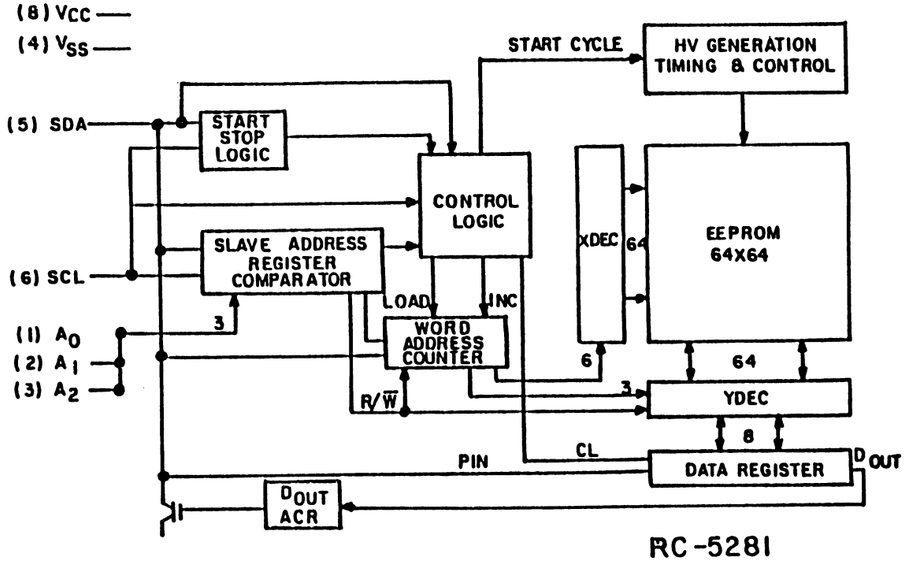
RC-7119

PIN CONFIGURATION



1 A_0 → TO V_{SS}
2 AND 3 A AND A ADDRESS INPUTS
4 V_{SS}
5 SDA SERIAL DATA — I^2C BUS
6 SCL SERIAL CLOCK — I^2C BUS
7 TEST INPUT — TO V_{SS}
8 V_{CC}

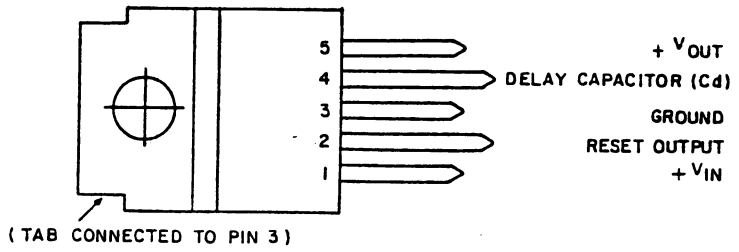
FUNCTION DIAGRAM

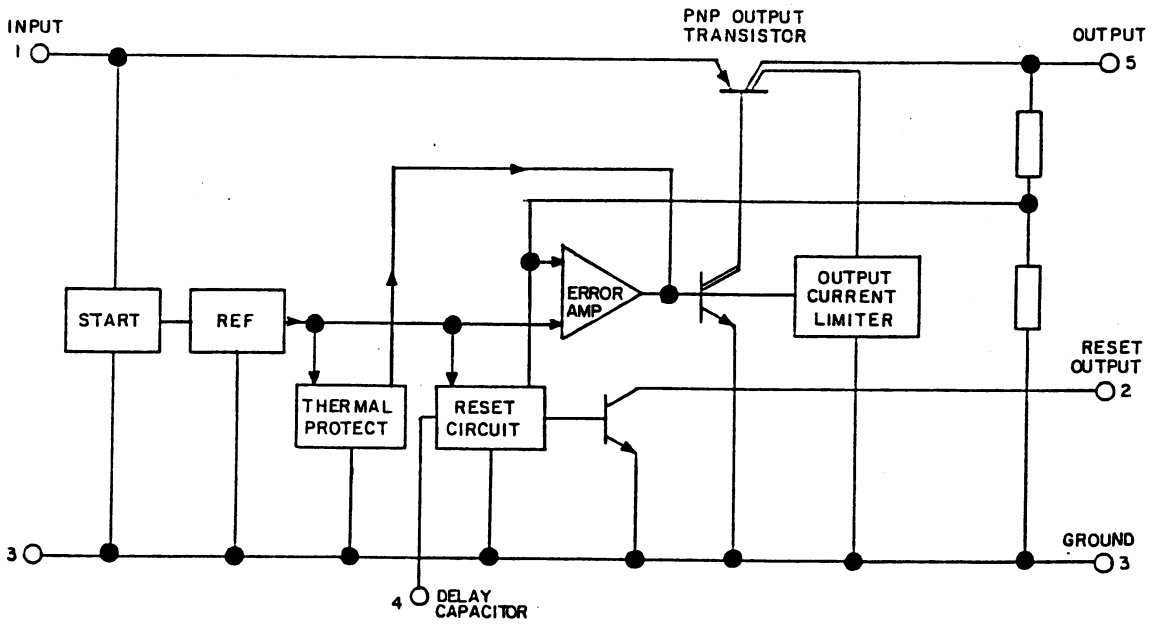


RC-5281

(U705)

VOLTAGE REGULATOR
(WITH RESET)
19A704970P1
PIN CONFIGURATION





RC-5286A